ISOLATED FEEDBACK GENERATOR

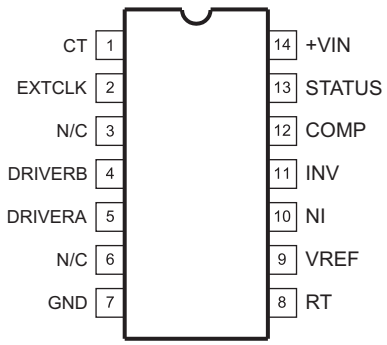
Check for Samples: UC2901-EP

FEATURES

- **Controlled Baseline**
  - **One Assembly/Test Site, One Fabrication Site**
- **Extended Temperature Performance of –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree** (1)
- **Amplitude-Modulation System for Transformer Coupling an Isolated Feedback Error Signal**
- **Low-Cost Alternative to Optical Couplers**
- **Internal 1% Reference and Error Amplifier**
- **Internal Carrier Oscillator Usable to 5 MHz**
- **Modulator Synchronizable to an External Clock**
- **Loop Status Monitor**

(1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

D PACKAGE
(TOP VIEW)



N/C = No internal connection

DESCRIPTION

The UC2901 is designed to solve many of the problems associated with closing a feedback control loop across a voltage isolation boundary. As a stable and reliable alternative to an optical coupler, UC2901 features an amplitude modulation system that allows a loop error signal to be coupled with a small RF transformer or capacitor.

The programmable, high-frequency oscillator within the UC2901 permits the use of smaller, less-expensive transformers, which can readily be built to meet the isolation requirements of today's line-operated power systems. As an alternative to RF operation, the external clock input to these devices allows synchronization to a system clock or to the switching frequency of an SMPS.

An additional feature is a status monitoring circuit that provides an active low output when the sensed error voltage is within ±10% of the reference. The DRIVERA output, DRIVERB output, and STATUS output are disabled until the input supply has reached a sufficient level to allow proper operation of the device.

Because these devices also can be used as a DC driver for optical couplers, the benefits of 4.5 V to 40 V supply operation, a 1% accurate reference, and a high-gain general-purpose amplifier offer advantages, even though an AC system may not be desired.

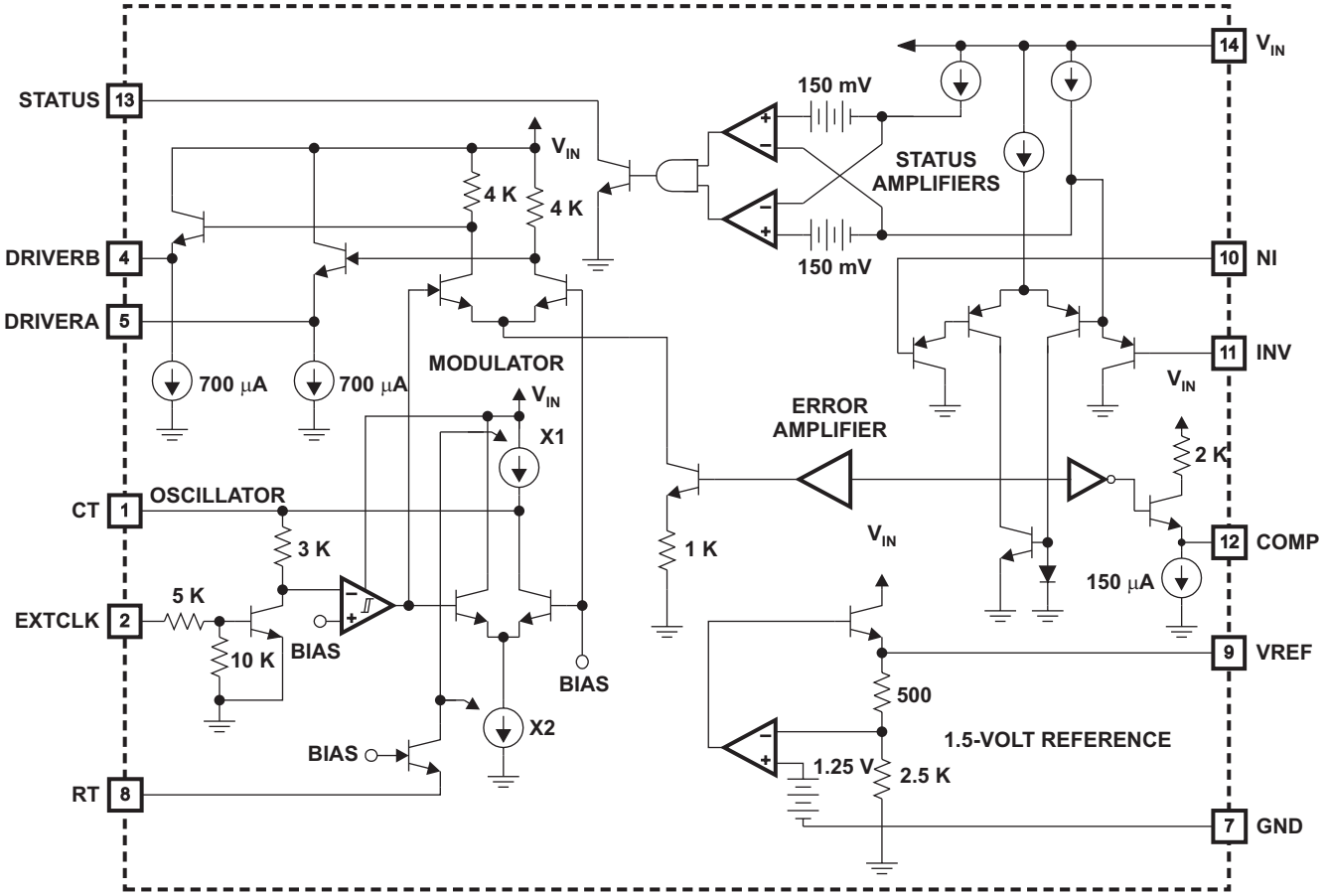
ORDERING INFORMATION

T_A	PACKAGE(1)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	D (SOIC)	UC2901MDREP	UC2901MEP

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

UC2901 SIMPLIFIED SCHEMATIC



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{IN}	Input supply voltage		40	V
	Reference output current		–10	mA
	Driver output current		–35	mA
	Status indicator voltage		40	V
	Status indicator current		20	mA
	External clock input		40	V
	Error amplifier inputs	–0.5	35	V
	Power dissipation at T_A = 25°C		1000	mW
	Operating junction temperature range	–55	150	°C
	Storage temperature range(2)	–65	150	°C
	Lead temperature (soldering, 10 seconds)		300	°C

(1) Voltages are referenced to ground, pin 7. Currents are positive into, and negative out of the specified terminal.
(2) Long-term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

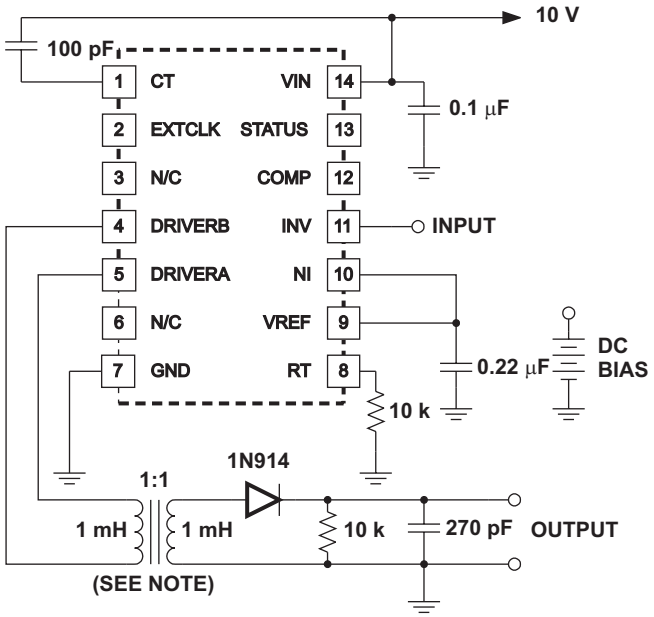
DISSIPATION RATING TABLE - FREE-AIR TEMPERATURE

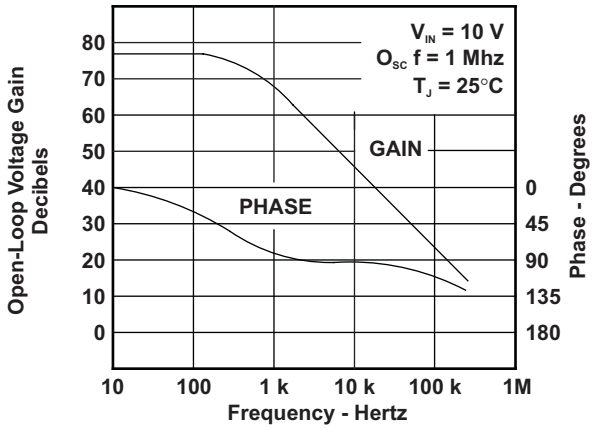
PACKAGE	AIR FLOW (CFM)	$T_A \leq 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 85°C$ POWER RATING	$T_A = 125°C$ POWER RATING
D	0	1000 mW	8 mW/°C	630 mW	510 mW	180 mW

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Reference Section					
Output voltage	T_A = 25°C	1.485	1.5	1.515	V
	$T_{MIN} \leq T_A \leq T_{MAX}$	1.470	1.5	1.530	
Line regulation	V_{IN} = 4.5 to 35 V		2	10	mV
Load regulation	I_{OUT} = 0 to 5 mA		4	10	mV
Short-circuit current	T_A = 25°C		–35	–55	mA
Error Amplifier Section (To Compensation Terminal)					
Input offset voltage	V_{CM} = 1.5 V		1	4	mV
Input bias current	V_{CM} = 1.5 V		–1	–3	µA
Input offset current	V_{CM} = 1.5 V		0.1	1	µA
Small-signal open-loop gain		40	60		dB
CMRR	V_{CM} = 0.5 V to 7.5 V	60	80		dB
PSRR	V_{IN} = 5 V to 25 V	80	100		dB
Output swing, ΔV_O		0.4	0.7		V
Maximum sink current		90	150		µA
Maximum source current		–2	–3		mA
Gain bandwidth product			1		MHz
Slew rate			0.3		V/µs
Modulators/Drivers Section (From Compensation Terminal)					
Voltage gain		11	12	13	dB
Output swing		±1.6	±2.8		V
Driver sink current		500	700		µA
Driver source current		–15	–35		mA
Gain bandwidth product			25		MHz
Oscillator Section					
Initial accuracy	T_A = 25°C	140	150	160	kHz
	$T_{MIN} \leq T_A \leq T_{MAX}$	130		170	kHz
Line sensitivity	V_{IN} = 5 V to 35 V		0.15	0.35	%/V
Maximum frequency	R_T = 10 K, C_T = 10 pF		5		MHz
External clock low threshold	Pin 1 (C_T) = V_{IN}	0.5			V
External clock high threshold	Pin 1 (C_T) = V_{IN}			1.6	V
Status Indicator Section					
Input voltage window	At E/A inputs, V_{CM} = 1.5 V	±135	±150	±165	mV
Saturation voltage	E/A Δinput = 0 V, I_{SINK} = 1.6 mA			0.45	V
Maximum output current	Pin 13 = 3 V, E/A Δ input = 0 V	8	15		mA
Leakage current	Pin 13 = 40 V, E/A Δ input = 0.2 V		0.05	1	µA
Supply current	V_{IN} = 35 V		5	8	mA
UVLO Section					
Drivers-enabled threshold	At input supply V_{IN}		3.9	4.5	V
Status output-enabled threshold	At input supply V_{IN}		3.9	4.5	V
Change in reference output	When VIN reaches UVLO threshold		–2	–30	mV





Note: Transformer Data: N1 = N2 = 20 TAWG 26
Core = Ferroxcube 3E2A Ferrite, 0.5" O.D. Toroid
Carrier Frequency = 1 Mhz

Figure 1. Transformer-Coupled Open-Loop Transfer Function

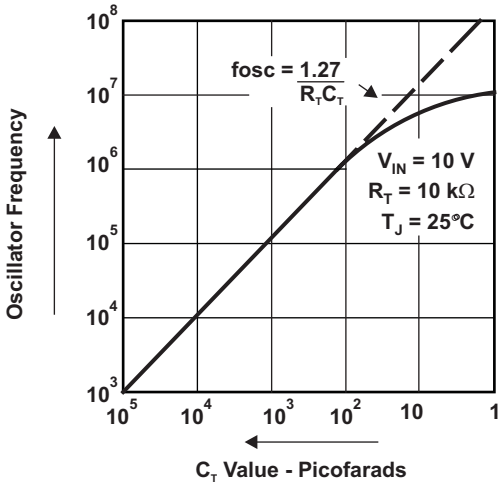


Figure 2. Oscillator Frequency

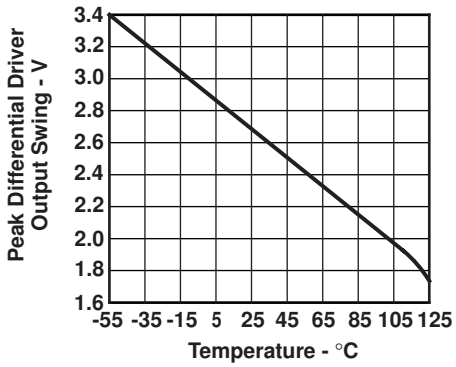


Figure 3. Typical Driver Output Swing vs Temperature

APPLICATION INFORMATION

The error amplifier compensation terminal, pin 12, is intended as a source of feedback to the amplifier's inverting input at pin 11. For most applications, a series DC blocking capacitor should be part of the feedback network. The amplifier is compensated internally for unity feedback.

The waveform at the driver outputs is a squarewave, with an amplitude that is proportional to the error amplifier input signal. There is a fixed 12 dB of gain from the error amplifier compensation pin to the modulator driver outputs. The frequency of the output waveform is controlled by either the internal oscillator or an external clock signal.

With the internal oscillator, the squarewave has a fixed 50% duty cycle. If the internal oscillator is disabled by connecting pin 1, C_R, to V_{IN}, then the frequency and duty cycle of the output is determined by the input clock waveform at pin 2. If the oscillator remains disabled, and there is not clock input at pin 2, there will be a linear 12-dB signal gain to one or the other of the driver outputs, depending on the DC state of pin 2.

The driver outputs are emitter followers that source a minimum of 15 mA of current. The sink current, internally limited at 700 mA, can be increased by adding resistors to ground at the driver outputs.

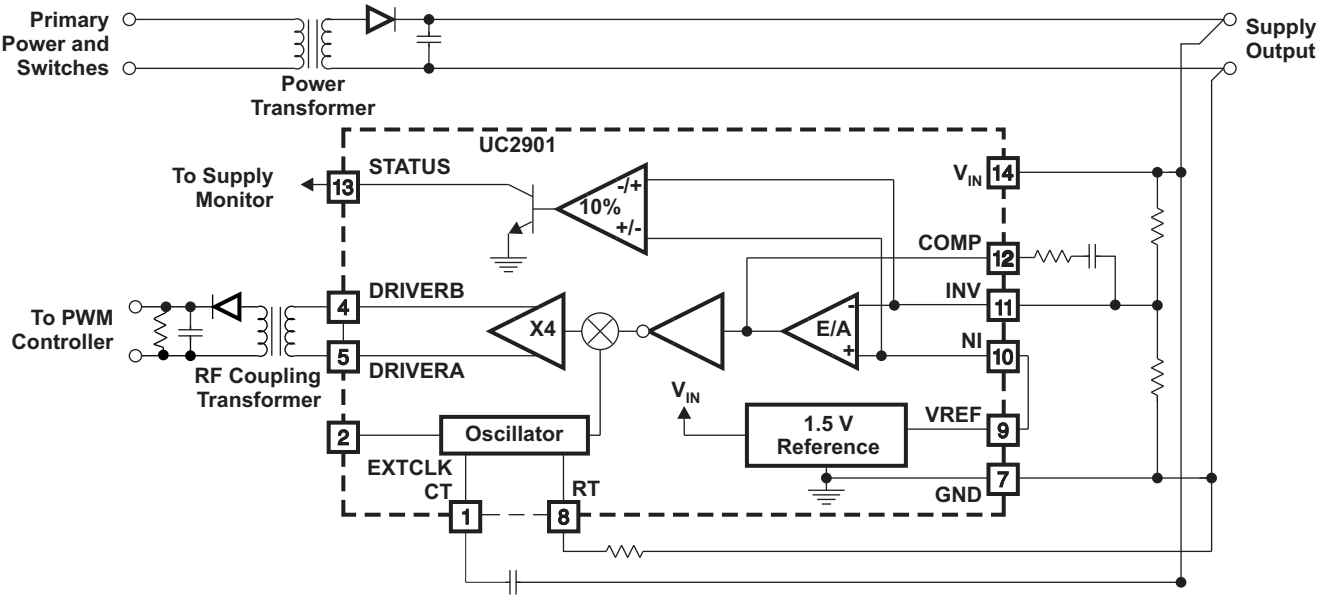


Figure 4. Transformer-Coupled Feedback

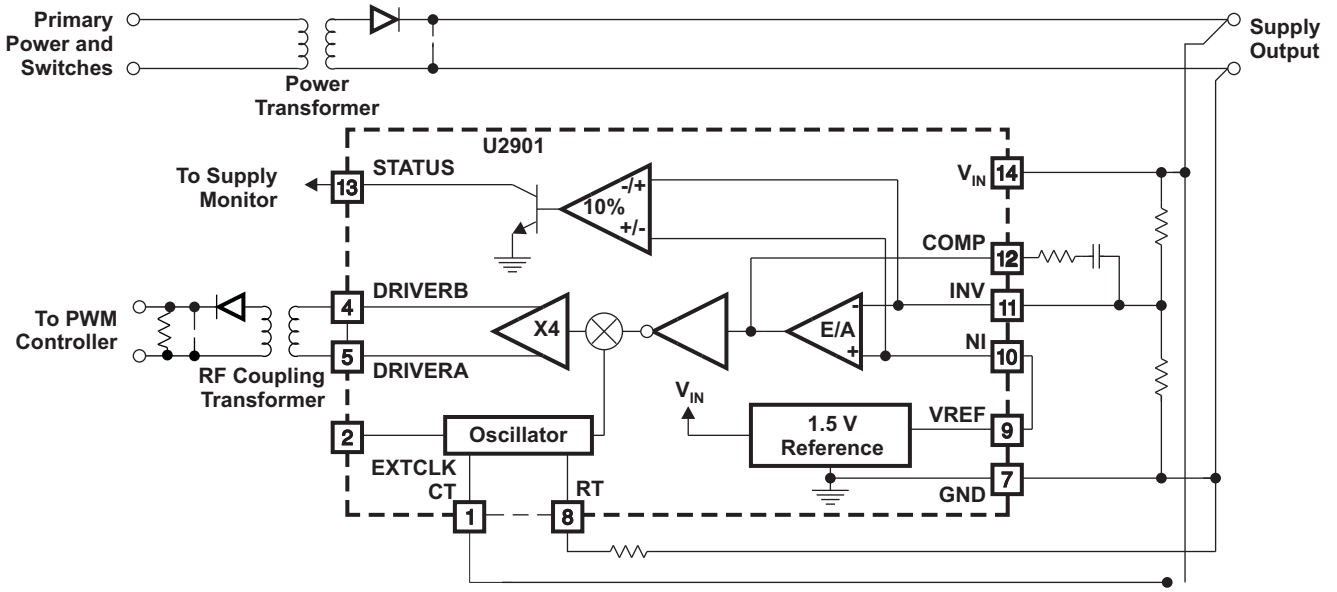


Figure 5. Feedback-Coupled at Switching Frequency

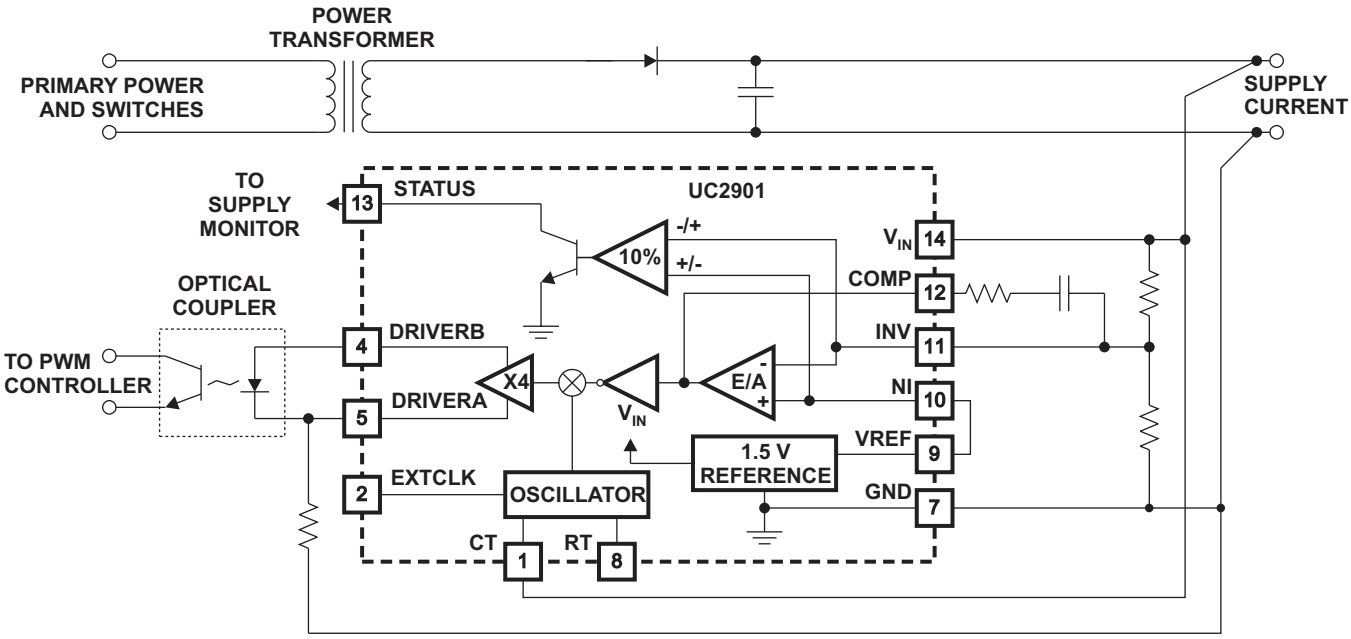


Figure 6. Optically-Coupled DC Feedback

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
UC2901MDREP	Active	Production	SOIC (D) | 14	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	UC2901MEP
UC2901MDREP.A	Active	Production	SOIC (D) | 14	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	UC2901MEP
V62/07609-01XE	Active	Production	SOIC (D) | 14	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	UC2901MEP

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

OTHER QUALIFIED VERSIONS OF UC2901-EP :

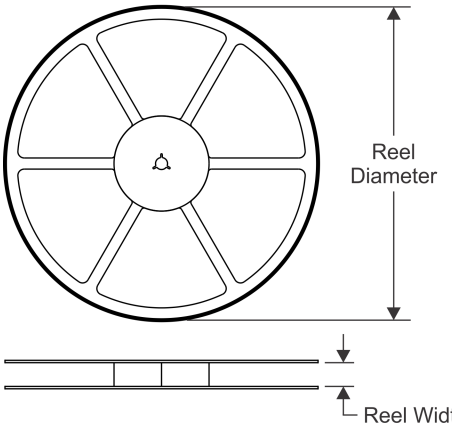
- Catalog : UC2901

NOTE: Qualified Version Definitions:

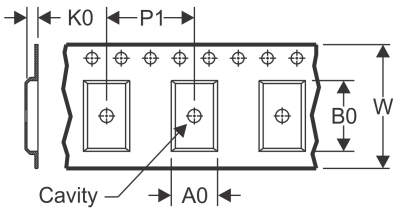
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

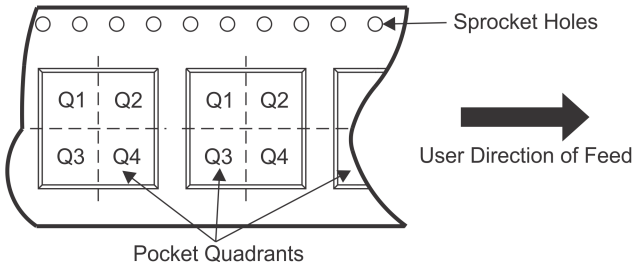


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

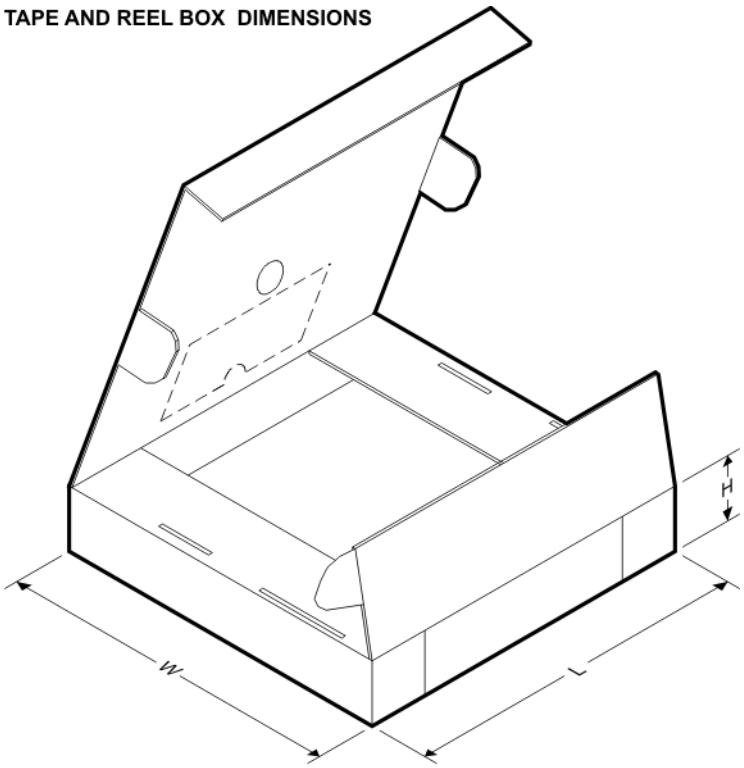
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

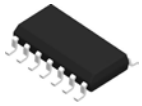
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2901MDREP	SOIC	D	14	2500	330.0	16.4	6.55	9.05	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2901MDREP	SOIC	D	14	2500	346.0	346.0	33.0

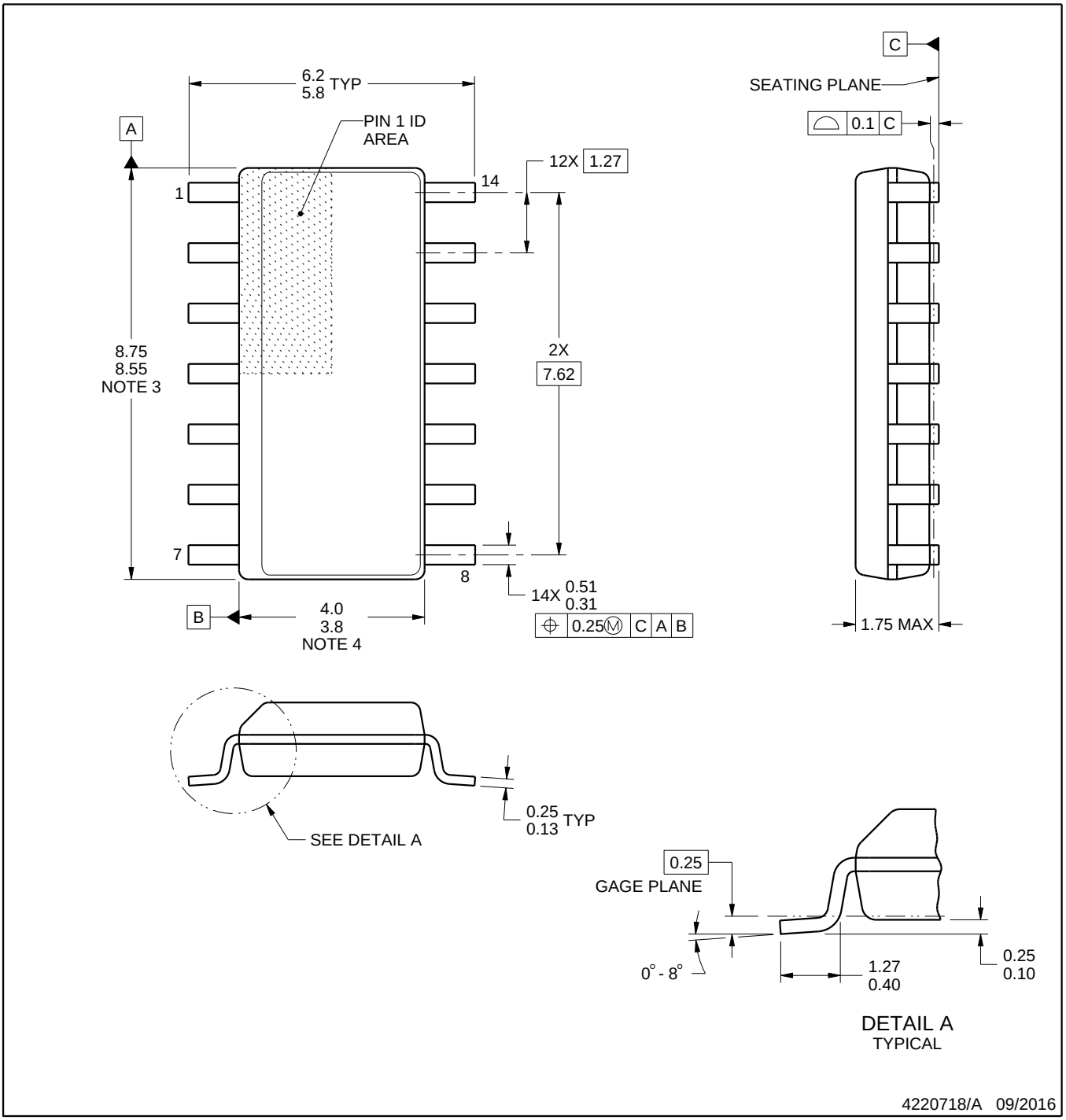


PACKAGE OUTLINE

D0014A

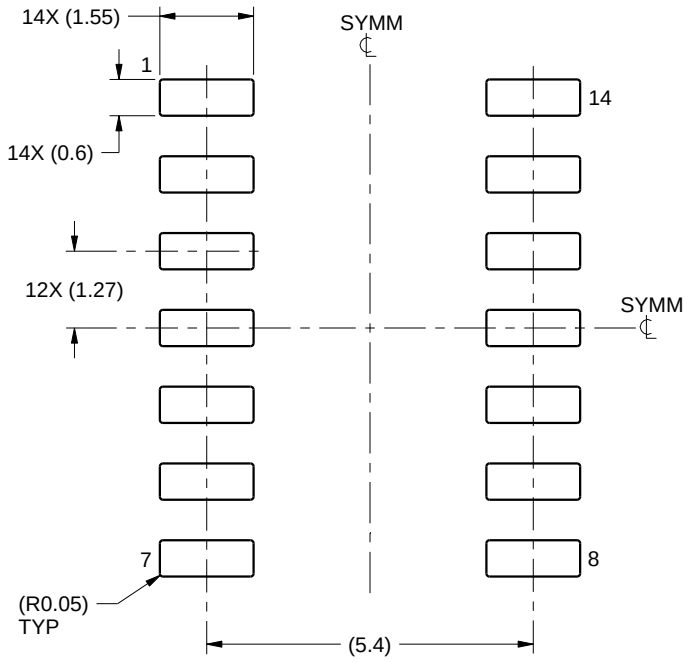
SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT

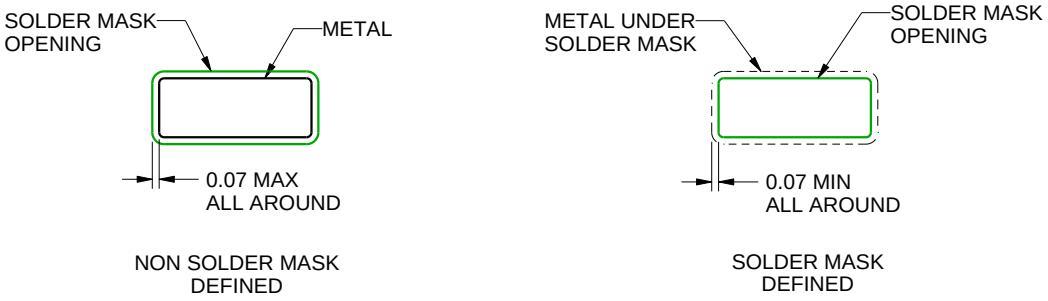


NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.



LAND PATTERN EXAMPLE
SCALE:8X



SOLDER MASK DETAILS

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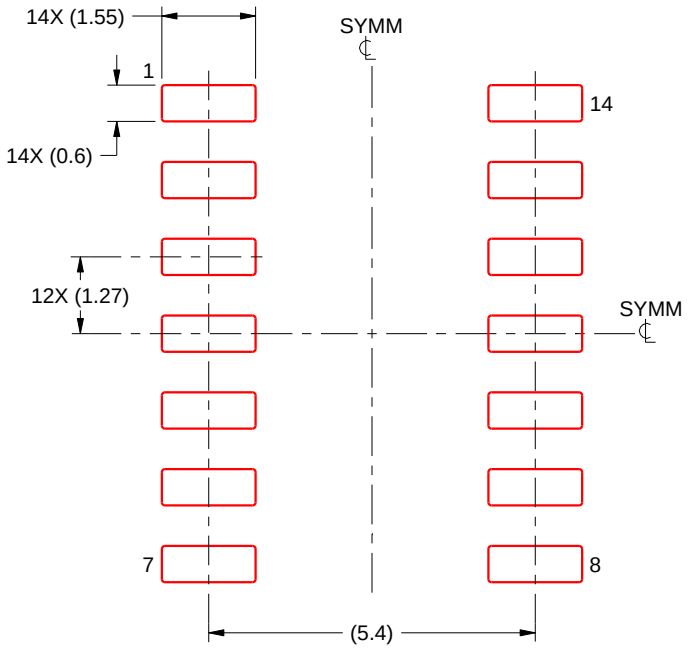
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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